Transistors

1.5±0.1

0.4±0.04

Base 2: Collector 3: Emitter MiniP3-F1 Package

0-0.25

4.5±0.1

Unit: mm

2SD2185

Silicon NPN epitaxial planar type

For low-frequency output amplification Complementary to 2SB1440

Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	<u>, 3.0±0.15</u>
Collector-base voltage (Emitter open)	V _{CBO}	50	V	
Collector-emitter voltage (Base open)	V _{CEO}	50	V	
Emitter-base voltage (Collector open)	V _{EBO}	5	V	
Collector current	I _C	3	A	
Peak collector current	I _{CP}	4	A	
Collector power dissipation *	P _C	1	W	Marking Symbol: 1H
Junction temperature	Tj	150	°C	at a start
Storage temperature	T _{stg}	-55 to +150	°C	
Note) *: Printed circuit board: Copper f	oil area of	1 cm ² or more	e, and the	ou tise
board thickness of 1.7 mm for	the collect	or portion		about later len
				2
Electrical Characteristics	$\Gamma_{\rm a} = 25^{\circ} C$	C±3°C)r offi

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

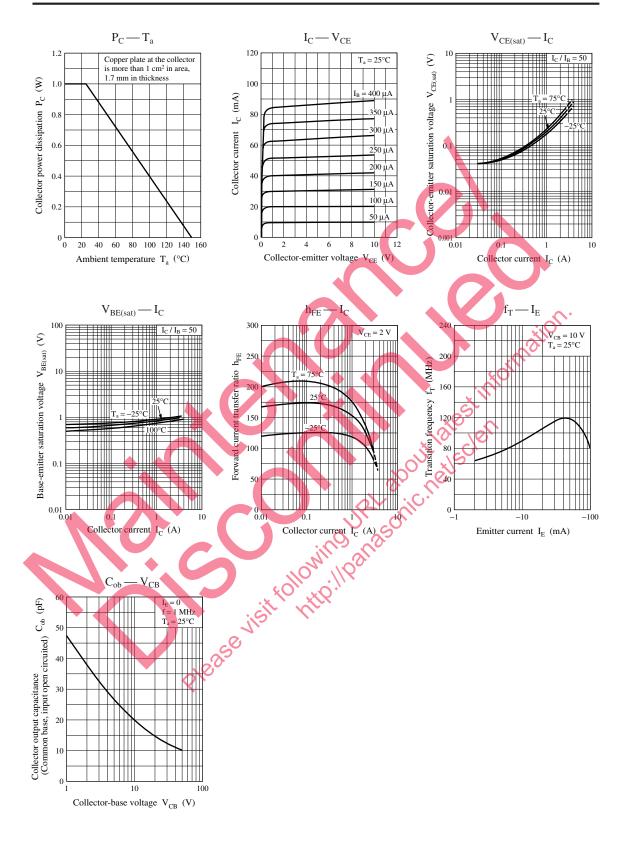
Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A_{\rm c} I_{\rm E} = 0$	50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V _{EBO}	$J_E = 10 \ \mu A, J_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20$ V, $I_E = 0$			0.1	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = 2 V, I_C = 200 mA$	120		340	
	h _{FE2}	$V_{CE} = 2 V, I_C = 1.0 A$	80			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{C} = 1 \text{ A}, I_{B} = 50 \text{ mA}$		0.15	0.30	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 50 \text{ mA}$		0.85	1.20	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		20	35	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	R	S			
h _{FE1}	120 to 240	170 to 340			

Panasonic



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